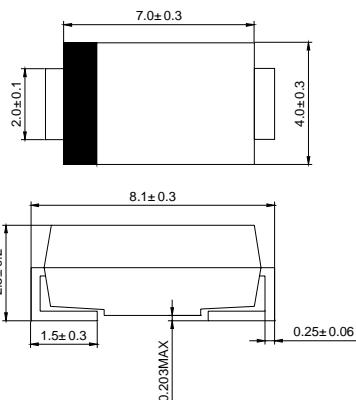


SCHOTTKY BARRIER RECTIFIER
FEATURES

- ◇ Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- ◇ For surface mounted applications
- ◇ Low profile package
- ◇ Built-in strain relief
- ◇ Metal silicon junction, majority carrier conduction
- ◇ High surge capability
- ◇ Low power loss, high efficiency
- ◇ For use in low voltage high frequency inverters, free wheeling and polarity protection applications
- ◇ Guardring for overvoltage protection
- ◇ High temperature soldering guaranteed: 250°C/10 seconds at terminals

MECHANICAL DATA

- ◇ Case: NSMC, molded plastic over passivated chip
- ◇ Terminals: Solder plated, solderable per MIL-STD-750, Method 2026
- ◇ Polarity: Color band denotes cathode end
- ◇ Weight:

**REVERSE VOLTAGE: 60 V
CURRENT: 3.0 A**
NSMC


Dimensions in millimeters

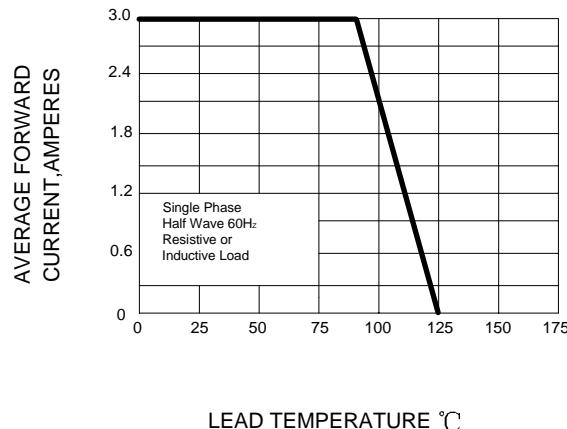
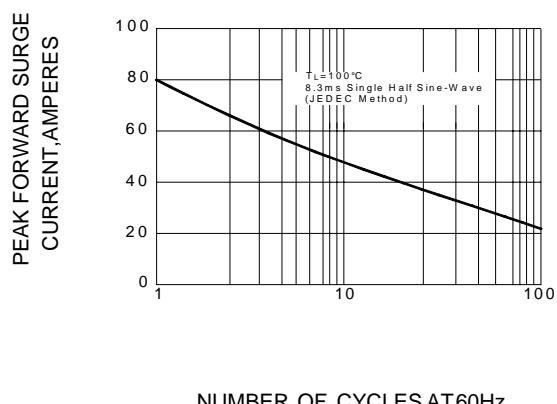
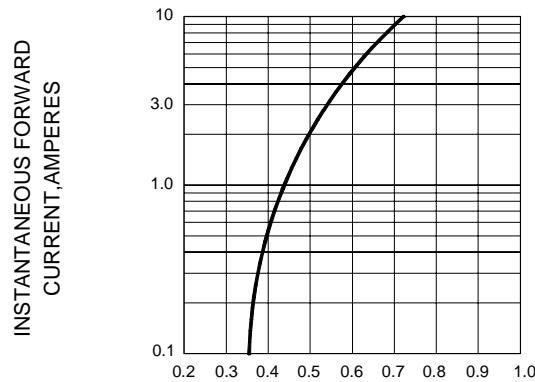
MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified

		B360L	UNITS
Maximum recurrent peak reverse voltage	V_{RRM}	60	V
Maximum RMS voltage	V_{RWS}	42	V
Maximum DC blocking voltage	V_{DC}	60	V
Maximum average forward rectified current at T_J (SEE FIG.1)	$I_{(AV)}$	3.0	A
Peak forward surge current 8.3ms single half-sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	80	A
Maximum instantaneous forward voltage at 3.0A (NOTE 1)	V_F	0.58	V
Maximum DC reverse current @ $T_A=25$ at rated DC blocking voltage @ $T_A=100$	I_R	2.5 10	mA
Typical thermal resistance (NOTE 2)	$R_{\theta JL}$	24	°C/W
Operating junction temperature range	T_J	-55---+150	°C
Storage temperature range	T_{STG}	-55---+150	°C

NOTE: 1. Pulse test: 300 μS pulse width, 1% duty cycle

2. Thermal resistance junction to lead.

FIG.1 - FORWARD DERATING CURVEFIG.2 - PEAK FORWARD SURGE CURRENTFIG.3 - TYPICAL FORWARD CHARACTERISTICSFIG.4 - TYPICAL REVERSE CHARACTERISTICS